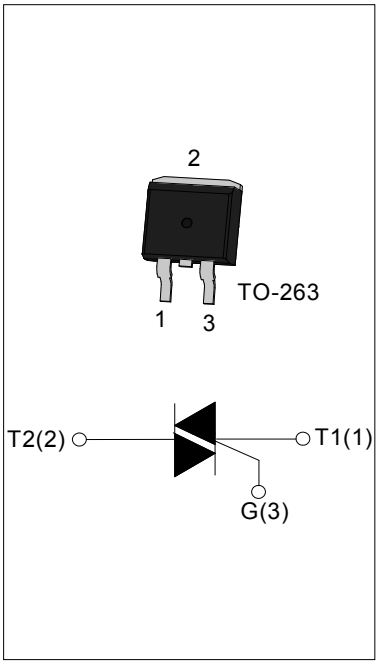
JST24 Series 25A TRIACs

Rev.9.0

DESCRIPTION:

With high ability to withstand the shock loading of large current, JST24 series triacs provide high dv/dt rate with strong resistance to electromagnetic interface. With high commutation performances, 3 quadrants products especially recommended focus on inductive load. Package TO-263 is RoHS compliant. (2011/65/EU)



MAIN FEATURES

Symbol	Value	Unit
$I_{T(RMS)}$	25	A
V_{DRM} /V_{RRM}	600/800/1200/1600	V

ABSOLUTE MAXIMUM RATINGS

Parameter		Symbol	Value	Unit
Storage junction temperature range		T_{stg}	-40-150	℃
Operating junction temperature range		T_j	-40-125	℃
Repetitive peak off-state voltage (T_j=25℃)		V_{DRM}	600/800/1200/1600	V
Repetitive peak reverse voltage (T_j=25℃)		V_{RRM}	600/800/1200/1600	V
RMS on-state current	TO-263 (T_C=75℃)	$I_{T(RMS)}$	25	A
Non repetitive surge peak on-state current (full cycle, F=50Hz)		I_{TSM}	250	A
I^2t value for fusing (tp=10ms)		I^2t	340	A^2s
Critical rate of rise of on-state current (I_G =2×I_{GT})		dI/dt	50	A/μs
Peak gate current		I_{GM}	4	A
Average gate power dissipation		$P_{G(AV)}$	1	W
Peak gate power		P_{GM}	10	W

ELECTRICAL CHARACTERISTICS (T_j=25℃ unless otherwise specified)

V_{DRM} /V_{RRM}: 600/800V

Symbol	Test Condition	Quadrant		JST24-600/800V		Unit
				BW	CW	
I_{GT}	V_D =12V R_L =33Ω	Ⅰ-Ⅱ-Ⅲ	MAX	50	35	mA
V_{GT}		Ⅰ-Ⅱ-Ⅲ	MAX	1.3		V
V_{GD}	V_D =V_{DRM} T_j =125℃ R_L =3.3KΩ	Ⅰ-Ⅱ-Ⅲ	MIN	0.2		V
I_L	I_G =1.2I_{GT}	Ⅰ-Ⅲ	MAX	80	70	mA
		Ⅱ		100	80	
I_H	I_T =100mA		MAX	75	50	mA
dV/dt	V_D=2/3V_{DRM} Gate Open T_j =125℃		MIN	1000	500	V/μs

V_{DRM} /V_{RRM}: 1200/1600V

Symbol	Test Condition	Quadrant		JST24-1200V/1600V		Unit
				BW	CW	
I_{GT}	V_D =12V R_L=33Ω	Ⅰ-Ⅱ-Ⅲ	MAX	50	35	mA
V_{GT}		Ⅰ-Ⅱ-Ⅲ	MAX	1.5		V
V_{GD}	V_D =V_{DRM} T_j =125℃ R_L =3.3KΩ	Ⅰ-Ⅱ-Ⅲ	MIN	0.2		V
I_L	I_G =1.2I_{GT}	Ⅰ-Ⅲ	MAX	90	70	mA
		Ⅱ		100	80	
I_H	I_T =100mA		MAX	80	60	mA
dV/dt	V_D=2/3V_{DRM} Gate Open T_j=125℃		MIN	1500	1000	V/μs

V_{DRM} /V_{RRM}: 600/800V

Symbol	Test Condition	Quadrant		JST24-600/800V		Unit
				B	C	
I_{GT}	V_D =12V R_L =33Ω	Ⅰ-Ⅱ-Ⅲ	MAX	50	25	mA
		Ⅳ		70	50	
V_{GT}		ALL	MAX	1.3		V
V_{GD}	V_D =V_{DRM} T_j =125℃ R_L =3.3KΩ	ALL	MIN	0.2		V

I_L	I_G =1.2I_{GT}	Ⅰ-Ⅲ-Ⅳ	MAX	80	70	mA
		Ⅱ	MAX	100	90	
I_H	I_T =100mA		MAX	75	60	mA
dV/dt	V_D=2/3V_{DRM} Gate Open T_j =125℃		MIN	500	200	V/μs

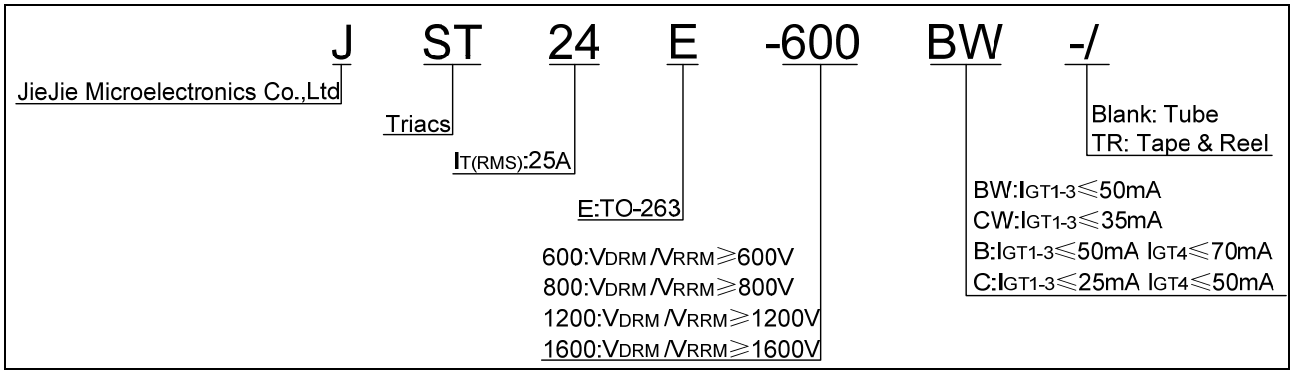
STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX)	Unit
V_{TM}	I_{TM} =35A tp=380μs	T_j=25℃	1.5	V
I_{DRM}	V_D =V_{DRM} V_R =V_{RRM}	T_j=25℃	5	μA
I_{RRM}		T_j=125℃	3	mA

THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	junction to case(AC)	TO-263	1.3	℃/W
$R_{th(j-a)}$	junction to ambient		45	

ORDERING INFORMATION



MARKING

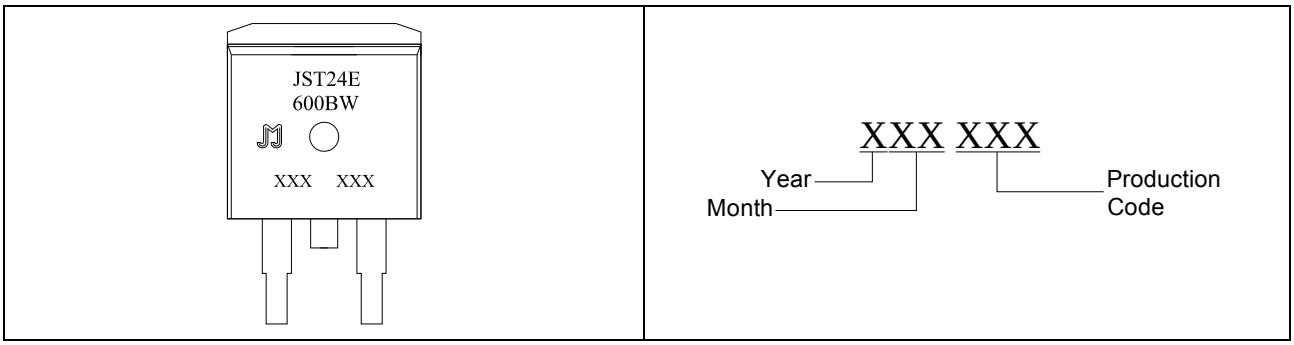


FIG.1: Maximum power dissipation versus RMS on-state current

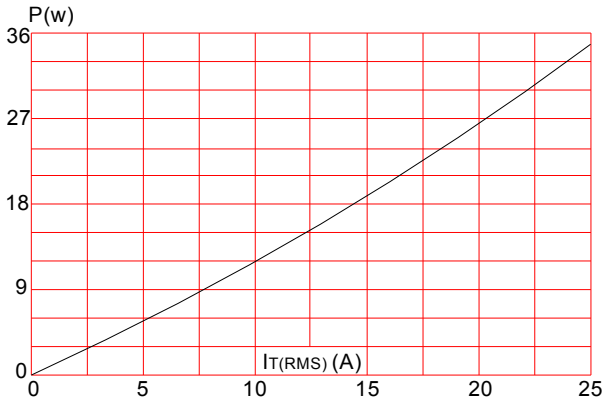


FIG.2: RMS on-state current versus ambient temperature (printed circuit board FR4, copper thickness:35μm)(full cycle)

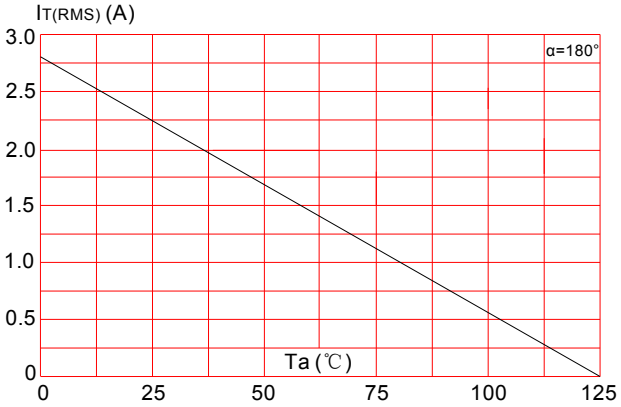


FIG.3: Surge peak on-state current versus number of cycles

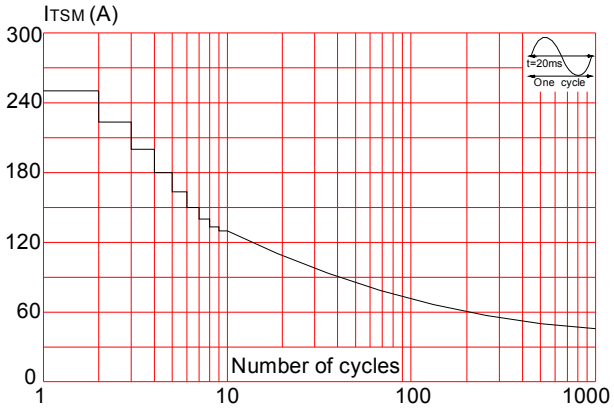


FIG.4: On-state characteristics (maximum values)

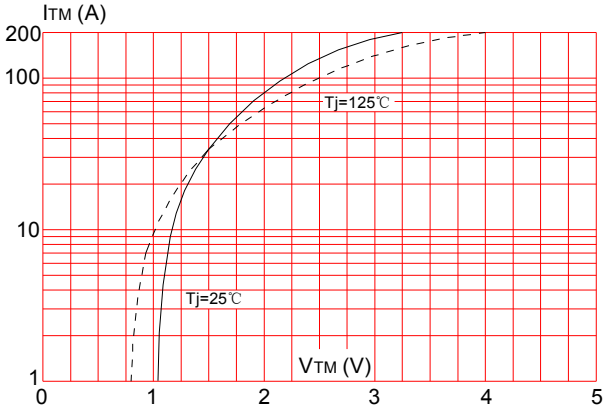


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp<20ms, and corresponging value of I^2t (dI/dt < 50A/μs)

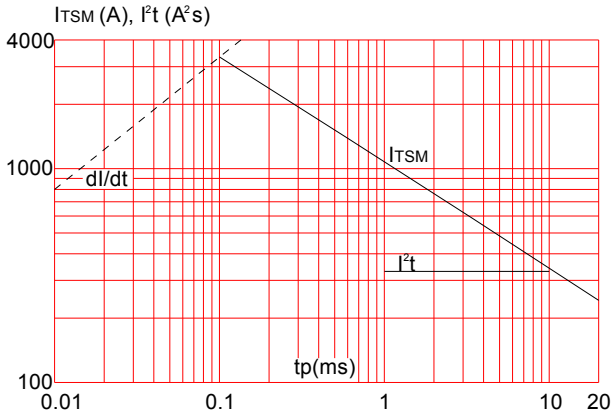
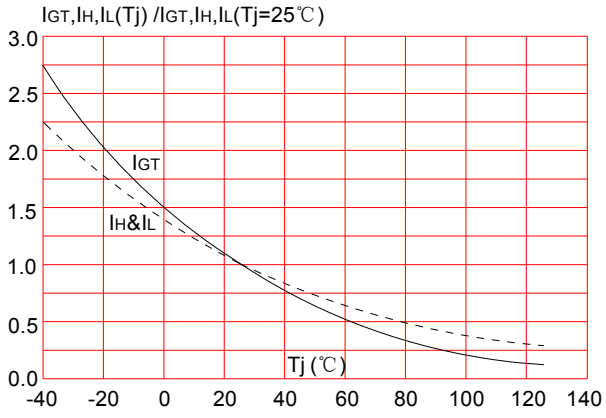
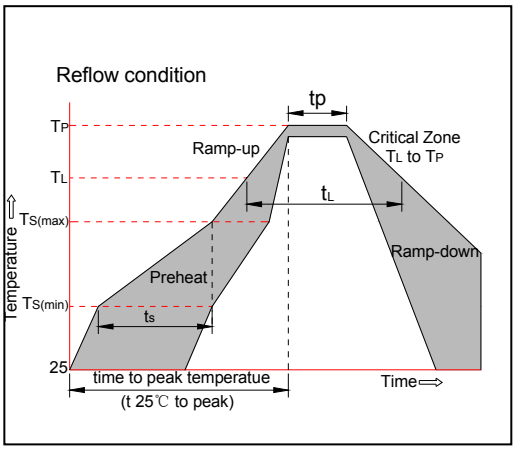


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature



SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see figure at right)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150℃
	-Temperature Max($T_{s(max)}$)	+200℃
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquidus Temp (T_L)to peak)		3℃/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3℃/sec. Max
Reflow	-Temperature(T_L) (Liquidus)	+217℃
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)℃
Time within 5℃of actual Peak Temp (t_p)		20-40secs.
Ramp-down Rate		6℃/sec. Max
Time 25℃ to Peak Temp (T_P)		8 min. Max
Do not exceed		+260℃



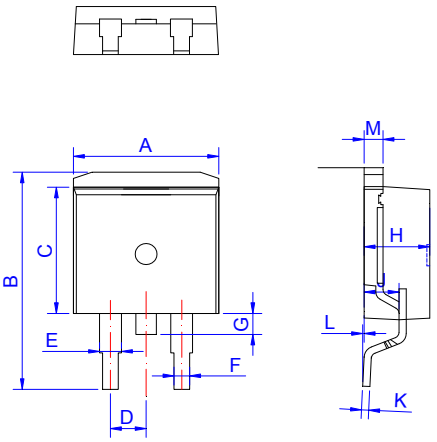
ORDERING INFORMATION

Order code	Voltage V_{DRM}/V_{RRM} (V)	IGT (mA)		Package	Base qty. (pcs)	Delivery mode
		Ⅰ-Ⅱ-Ⅲ				
JST24E-600(800/1200/1600)BW	600/800/1200/1600	50		TO-263	50	Tube
JST24E-600(800/1200/1600)CW	600/800/1200/1600	35				
Order code	Voltage V_{DRM}/V_{RRM} (V)	IGT(mA)		Package	Base qty. (pcs)	Delivery mode
		Ⅰ-Ⅱ-Ⅲ	Ⅳ			
JST24E-600(800)B	600/800	50	70	TO-263	800	Tape & Reel
JST24E-600(800)C	600/800	25	50			

Document Revision History

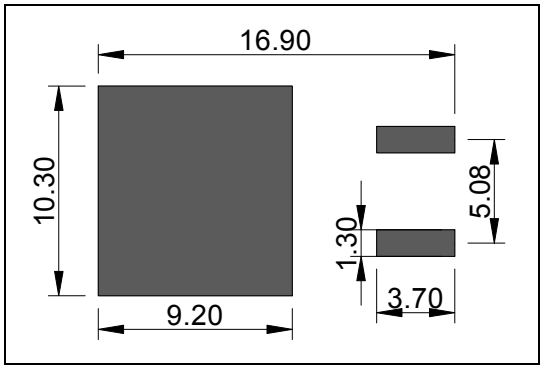
Date	Revision	Changes
April 9, 2021	9	Last update

PACKAGE MECHANICAL DATA

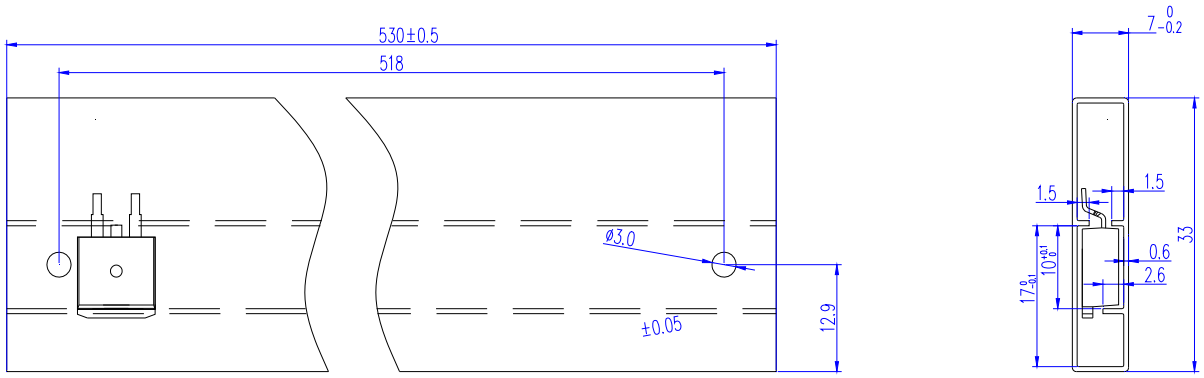


Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	9.90		10.20	0.390		0.402
B	14.70		15.80	0.579		0.622
C	9.4		9.6	0.37		0.378
D		2.54			0.100	
E	1.20		1.40	0.047		0.055
F	0.75		0.85	0.029		0.033
G			1.75			0.069
H	4.40		4.70	0.173		0.185
J	2.30		2.70	0.091		0.106
K	0.38		0.55	0.015		0.022
L	0	0.10	0.25	0	0.004	0.010
M	1.25		1.35	0.049		0.053

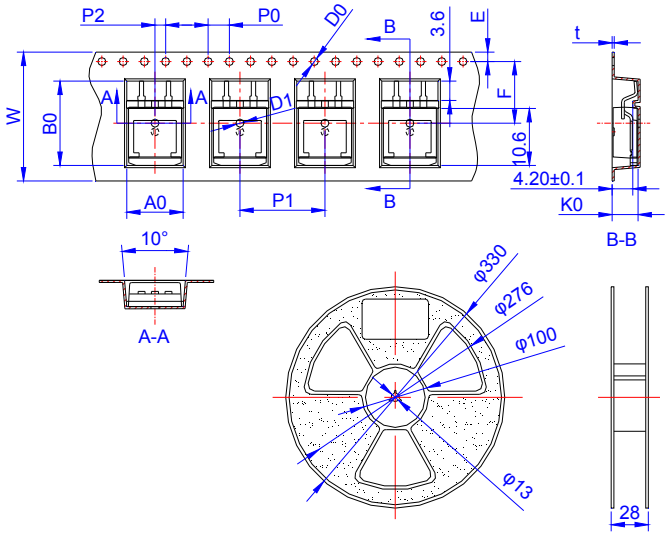
FOOTPRINT-TO-263 (dimensions in mm)



DELIVERY MODE



PACKAGE	OUTLINE	TUBE (PCS)	INNER BOX (PCS)	PER CARTON
TO-263	TUBE	50	1,000	5,000



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
W	23.70	24.00	24.30	0.933	0.945	0.957
E	1.65	1.75	1.85	0.065	0.069	0.073
F	11.40	11.50	11.60	0.449	0.453	0.457
D0	-	1.50	1.60	-	0.059	0.063
D1	-	1.50	1.60	-	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	15.90	16.00	16.10	0.626	0.630	0.634
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	10.80	10.90	11.00	0.425	0.429	0.433
B0	16.20	16.30	16.40	0.638	0.642	0.646
K0	4.80	4.90	5.00	0.189	0.193	0.197
t	0.35	0.40	0.45	0.014	0.016	0.018

PACKAGE	OUTLINE	REEL (PCS)	PER CARTON (PCS)	TAPE & REEL
TO-263	TAPING	800	4,000	13 inch